DERTIFICATE OF Tipplicant(s): Quon et al.	RANSMISSION BY FAC	CSIMILE (37 CFR 1.8)	Docket No. F1S920030197US1
Application No. 10/707,021	Filing Date November 14, 2003	Examiner Chris Chu	Group Art Unit 2814
vention: STABILIZING	COPPER OVERLAYER FO	R ENHANCED C4 INTERCON	NECT RELIABILITY
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hereby certify that this	A	mendment Under 37 C.F.R. 1.11	16
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 $\sum_{i=1}^{n} x_i$

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10/707,021

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Quon et al.

Serial No.: 10/707,021

Group Art Unit: 2814

Filed: November 14, 2003

Examiner: Chris Chu

For: STABILIZING COPPER OVERLAYER FOR ENHANCED C4

INTERCONNECT RELIABILITY

Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

AMENDMENT UNDER 37 C.F.R. §1.116

Sir:

In response to the Office Action mailed November 30, 2004, please amend the aboveidentified patent application as follows:

IN THE CLAIMS:

Please cancel claims 6, 11, 17, and 22 and amend the remaining claims as follows: